# imall

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40V COMPLEMENTARY NPN-PNP SMALL SIGNAL TRANSISTOR IN SOT363

#### **Features**

- Complementary Pair One 3904-Type NPN
  One 3906-Type PNP
- Ultra-Small Surface Mount Package
- Epitaxial Planar Die Construction
- Ideal for Low Power Amplification and Switching
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

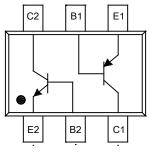
SOT363



Top View

#### **Mechanical Data**

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Finish. Solderable per MIL-STD-202, Method 208 3
- Weight: 0.006 grams (approximate)



E1, B1, C1 = PNP 3906 E2, B2, C2 = NPN 3904

Device Schematic and Pinout Top View

#### Ordering Information (Note 4)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
MMDT3946-7-F	AEC-Q101	K46	7	8	3,000
MMDT3946-7R-F	AEC-Q101	K46	7	8	3,000

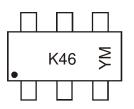
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and</li>
 <1000ppm antimony compounds.</li>

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

#### **Marking Information**



K46 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: A = 2013) M = Month (ex: 9 = September)

Date Code Key

Year	2010		2011	2012		2013	2014		2015	2016		2017
Code	Х		Y	Z		А	В		С	D		E
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D



#### Absolute Maximum Ratings, NPN 3904 (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	60	V
Collector-Emitter Voltage	V <sub>CEO</sub>	40	V
Emitter-Base Voltage	V <sub>EBO</sub>	6.0	V
Collector Current	Ic	200	mA

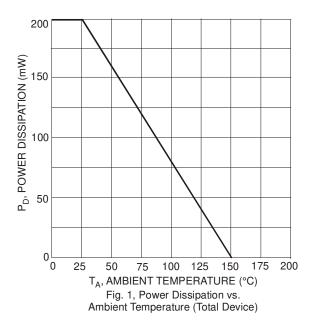
#### Absolute Maximum Ratings, PNP 3906 (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-40	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-40	V
Emitter-Base Voltage	V <sub>EBO</sub>	-5.0	V
Collector Current	Ι <sub>C</sub>	-200	mA

### **Thermal Characteristics, Total Device** (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	200	mW
Thermal Resistance, Junction to Ambient Air (Note 5)	$R_{ extsf{ heta}JA}$	625	°C/W
Operating and Storage Temperature Range	TJ, T <sub>STG</sub>	-55 to +150	٥C

Notes: 5. For a device mounted on minimum recommended pad layout that is on a single-sided 0.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.





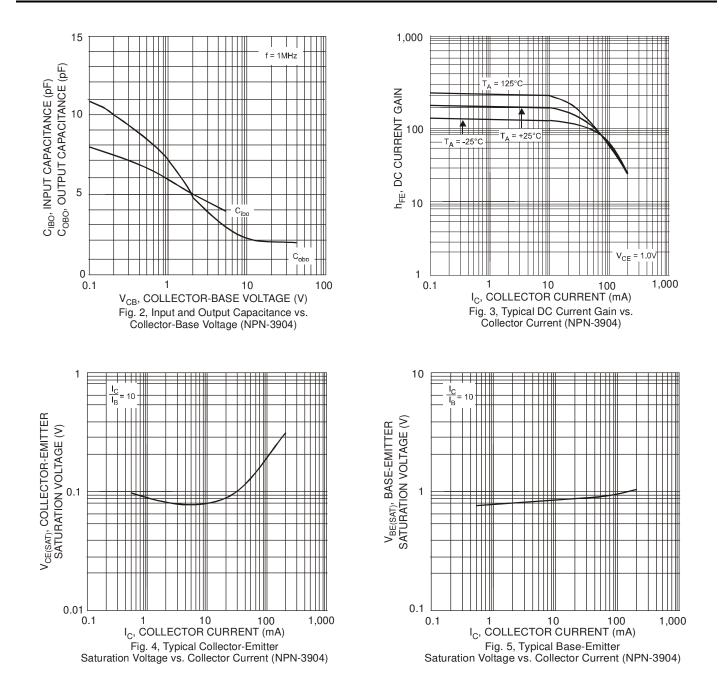
## Electrical Characteristics, NPN 3904 (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)				•	
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	60	_	V	$I_{C} = 10 \mu A, I_{E} = 0$
Collector-Emitter Breakdown Voltage	BV <sub>CEO</sub>	40	_	V	$I_{\rm C} = 1.0 {\rm mA}, I_{\rm B} = 0$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	5.0	6.0	V	$I_{E} = 10 \mu A, I_{C} = 0$
Collector Cutoff Current	I <sub>CEX</sub>	_	50	nA	$V_{CE} = 30V, V_{EB(OFF)} = 3.0V$
Base Cutoff Current	I <sub>BL</sub>	_	50	nA	$V_{CE} = 30V, V_{EB(OFF)} = 3.0V$
ON CHARACTERISTICS (Note 6)					
Static Forward Current Transfer Ratio	h <sub>FE</sub>	40 70 100 60 30	 300 	_	$\begin{array}{l} I_{C} = \ 100\mu A, \ V_{CE} = \ 1.0V \\ I_{C} = \ 1.0mA, \ V_{CE} = \ 1.0V \\ I_{C} = \ 10mA, \ V_{CE} = \ 1.0V \\ I_{C} = \ 50mA, \ V_{CE} = \ 1.0V \\ I_{C} = \ 100mA, \ V_{CE} = \ 1.0V \end{array}$
Collector-Emitter Saturation Voltage	V <sub>CE(SAT)</sub>		0.20 0.30	v	$\begin{split} I_C &= 10 m A, \ I_B = 1.0 m A \\ I_C &= 50 m A, \ I_B = 5.0 m A \end{split}$
Base-Emitter Saturation Voltage	$V_{BE(SAT)}$	0.65	0.85 0.95	v	$I_{C} = 10mA, I_{B} = 1.0mA$ $I_{C} = 50mA, I_{B} = 5.0mA$
SMALL SIGNAL CHARACTERISTICS			-	_	
Output Capacitance	C <sub>obo</sub>	_	4.0	pF	$V_{CB} = 5.0V, f = 1.0MHz, I_E = 0$
nput Capacitance	Cibo		8.0	pF	$V_{EB} = 0.5V, f = 1.0MHz, I_{C} = 0$
nput Impedance	h <sub>ie</sub>	1.0	10	kΩ	
Voltage Feedback Ratio	h <sub>re</sub>	0.5	8.0	x 10 <sup>-4</sup>	$V_{CE} = 10V, I_{C} = 1.0mA,$
Small Signal Current Gain	h <sub>fe</sub>	100	400	—	f = 1.0 kHz
Output Admittance	h <sub>oe</sub>	1.0	40	μS	
Current Gain-Bandwidth Product	f <sub>T</sub>	300	—	MHz	$V_{CE} = 20V, I_C = 20mA,$ f = 100MHz
Noise Figure	NF		5.0	dB	$\label{eq:VCE} \begin{split} V_{CE} &= 5.0V, \ I_C = 100 \mu A, \\ R_S &= 1.0 k \Omega, \ f = 1.0 k Hz \end{split}$
SWITCHING CHARACTERISTICS	· · · · · ·			_	
Delay Time	t <sub>d</sub>		35	ns	$V_{CC} = 3.0V, I_{C} = 10mA,$
Rise Time	tr	_	35	ns	$V_{BE(off)} = -0.5V, I_{B1} = 1.0mA$
Storage Time	ts	_	200	ns	$V_{CC} = 3.0V, I_{C} = 10mA,$
Fall Time	t <sub>f</sub>	_	50	ns	$I_{B1} = I_{B2} = 1.0 \text{mA}$

Notes: 6. Measured under pulsed conditions. Pulse width  $\leq$  300µs. Duty cycle  $\leq$  2%



### Typical Electrical Characteristics, NPN 3904 (@T<sub>A</sub> = +25°C unless otherwise specified.)



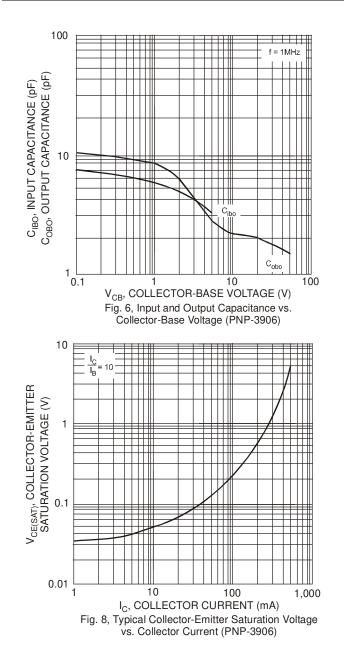


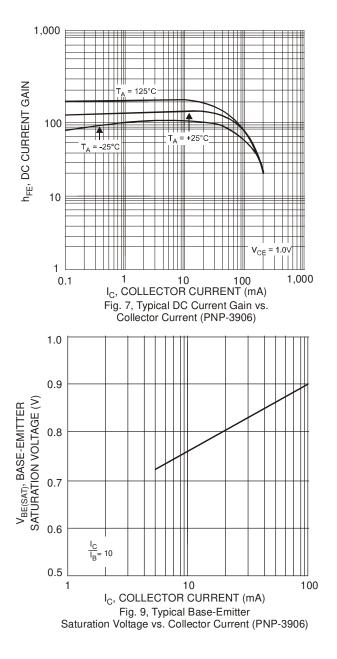
## Electrical Characteristics, PNP 3906 (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)				•	·
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	-40	_	V	$I_{\rm C} = -10 \mu A, I_{\rm E} = 0$
Collector-Emitter Breakdown Voltage	BV <sub>CEO</sub>	-40	_	V	$I_{\rm C} = -1.0 {\rm mA}, I_{\rm B} = 0$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	-5.0	_	V	$I_{\rm E} = -10 \mu A, I_{\rm C} = 0$
Collector Cutoff Current	ICEX	_	-50	nA	$V_{CE} = -30V, V_{EB(OFF)} = -3.0V$
Base Cutoff Current	I <sub>BL</sub>	_	-50	nA	$V_{CE} = -30V, V_{EB(OFF)} = -3.0V$
ON CHARACTERISTICS (Note 6)				•	•
Static Forward Current Transfer Ratio	h <sub>FE</sub>	60 80 100 60 30	 300 		$\begin{array}{ll} I_{C}=&-100\mu A,V_{CE}=&-1.0V\\ I_{C}=&-1.0mA,V_{CE}=&-1.0V\\ I_{C}=&-10mA,V_{CE}=&-1.0V\\ I_{C}=&-50mA,V_{CE}=&-1.0V\\ I_{C}=&-100mA,V_{CE}=&-1.0V \end{array}$
Collector-Emitter Saturation Voltage	V <sub>CE(SAT)</sub>	_	-0.25 -0.40	V	$I_{C} = -10mA$ , $I_{B} = -1.0mA$ $I_{C} = -50mA$ , $I_{B} = -5.0mA$
Base-Emitter Saturation Voltage	$V_{BE(SAT)}$	-0.65	-0.85 -0.95	v	$I_{C} = -10mA$ , $I_{B} = -1.0mA$ $I_{C} = -50mA$ , $I_{B} = -5.0mA$
SMALL SIGNAL CHARACTERISTICS					
Output Capacitance	C <sub>obo</sub>	_	4.5	pF	$V_{CB} = -5.0V, f = 1.0MHz, I_E = 0$
nput Capacitance	C <sub>ibo</sub>	_	10	pF	$V_{EB} = -0.5V, f = 1.0MHz, I_{C} = 0$
nput Impedance	h <sub>ie</sub>	2.0	12	kΩ	
Voltage Feedback Ratio	h <sub>re</sub>	0.1	10	x 10 <sup>-4</sup>	$V_{CE} = 10V, I_{C} = 1.0mA,$
Small Signal Current Gain	h <sub>fe</sub>	100	400		f = 1.0 kHz
Dutput Admittance	h <sub>oe</sub>	3.0	60	μS	
Current Gain-Bandwidth Product	f <sub>T</sub>	250	—	MHz	$\label{eq:VCE} \begin{array}{l} V_{CE} = -20V, \ I_C = -10mA, \\ f = 100MHz \end{array}$
Noise Figure	NF		4.0	dB	$V_{CE} = -5.0V, I_C = -100 \mu A,$ $R_S = 1.0 k\Omega, f = 1.0 kHz$
SWITCHING CHARACTERISTICS	· · ·			·	
Delay Time	t <sub>d</sub>		35	ns	$V_{CC} = -3.0V, I_{C} = -10mA,$
Rise Time	tr	_	35	ns	$V_{BE(off)} = 0.5V, I_{B1} = -1.0mA$
Storage Time	t <sub>s</sub>	_	225	ns	$V_{CC} = -3.0V, I_{C} = -10mA,$
-all Time	t <sub>f</sub>	_	75	ns	$I_{B1} = I_{B2} = -1.0 \text{mA}$



## Typical Electrical Characteristics, PNP 3906 (@T<sub>A</sub> = +25°C unless otherwise specified.)

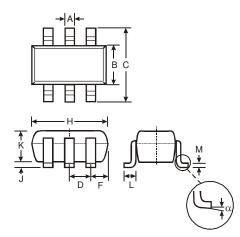






#### **Package Outline Dimensions**

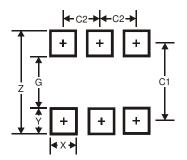
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	SOT363							
Dim	Min	Max	Тур					
Α	0.10	0.30	0.25					
В	1.15	1.35	1.30					
С	2.00	2.20	2.10					
D	0.65 Typ							
F	0.40	0.45	0.425					
Н	1.80	2.20	2.15					
J	0	0.10	0.05					
Κ	0.90	1.00	1.00					
L	0.25	0.40	0.30					
Μ	0.10	0.22	0.11					
α	0°	8°	-					
All	Dimen	isions i	n mm					

#### **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.5
G	1.3
Х	0.42
Y	0.6
C1	1.9
C2	0.65



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